

**N-Ch 100V Fast Switching MOSFETs**
**Description**

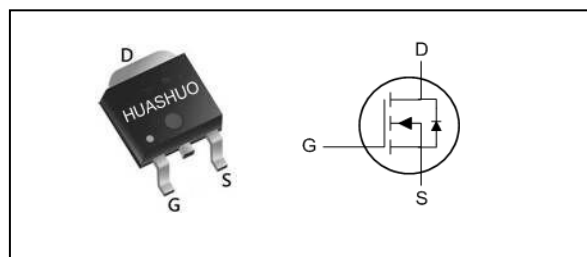
The HSU0028 is the high cell density trench N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The HSU0028 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

- Green Device Available
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Advanced high cell density Trench technology

**Product Summary**

|                  |     |            |
|------------------|-----|------------|
| $V_{DS}$         | 100 | V          |
| $R_{DS(ON),max}$ | 66  | m $\Omega$ |
| $I_D$            | 15  | A          |

**TO252 Pin Configuration**

**Absolute Maximum Ratings**

| Symbol                      | Parameter                                             | Rating     | Units            |
|-----------------------------|-------------------------------------------------------|------------|------------------|
| $V_{DS}$                    | Drain-Source Voltage                                  | 100        | V                |
| $V_{GS}$                    | Gate-Source Voltage                                   | $\pm 20$   | V                |
| $I_D@T_C=25^\circ\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V <sub>1</sub> | 15         | A                |
| $I_D@T_C=100^\circ\text{C}$ | Continuous Drain Current, $V_{GS}$ @ 10V <sub>1</sub> | 10         | A                |
| $I_D@T_A=25^\circ\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V <sub>1</sub> | 4          | A                |
| $I_D@T_A=70^\circ\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V <sub>1</sub> | 3          | A                |
| $I_{DM}$                    | Pulsed Drain Current <sub>2</sub>                     | 25         | A                |
| EAS                         | Single Pulse Avalanche Energy <sub>3</sub>            | 0.8        | mJ               |
| $I_{AS}$                    | Avalanche Current                                     | 4          | A                |
| $P_D@T_C=25^\circ\text{C}$  | Total Power Dissipation <sub>4</sub>                  | 30         | W                |
| $P_D@T_A=25^\circ\text{C}$  | Total Power Dissipation <sub>4</sub>                  | 2.7        | W                |
| $T_{STG}$                   | Storage Temperature Range                             | -55 to 175 | $^\circ\text{C}$ |
| $T_J$                       | Operating Junction Temperature Range                  | -55 to 175 | $^\circ\text{C}$ |

**Thermal Data**

| Symbol          | Parameter                                        | Typ. | Max. | Unit               |
|-----------------|--------------------------------------------------|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient <sub>1</sub> | ---  | 55   | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sub>1</sub>    | ---  | 5    | $^\circ\text{C/W}$ |

**N-Ch 100V Fast Switching MOSFETs**
**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

| Symbol              | Parameter                                      | Conditions                                                                           | Min. | Typ. | Max. | Unit |
|---------------------|------------------------------------------------|--------------------------------------------------------------------------------------|------|------|------|------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                           | 100  | ---  | ---  | V    |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =5A                                             | ---  | ---  | 66   | mΩ   |
|                     |                                                | V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A                                            | ---  | ---  | 85   |      |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA                             | 1.5  | ---  | 2.9  | V    |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                   | V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                      | ---  | ---  | 10   | uA   |
|                     |                                                | V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                      | ---  | ---  | 100  |      |
| I <sub>GSS</sub>    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                           | ---  | ---  | ±100 | nA   |
| g <sub>fs</sub>     | Forward Transconductance                       | V <sub>DS</sub> =5V, I <sub>D</sub> =5A                                              | ---  | 14   | ---  | S    |
| R <sub>g</sub>      | Gate Resistance                                | V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz                                     | ---  | 3    | ---  | Ω    |
| Q <sub>g</sub>      | Total Gate Charge (10V)                        | V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A                       | ---  | 11.9 | ---  | nC   |
| Q <sub>gs</sub>     | Gate-Source Charge                             |                                                                                      | ---  | 2.6  | ---  |      |
| Q <sub>gd</sub>     | Gate-Drain Charge                              |                                                                                      | ---  | 1.7  | ---  |      |
| T <sub>d(on)</sub>  | Turn-On Delay Time                             | V <sub>DD</sub> =50V, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω<br>I <sub>D</sub> =5A | ---  | 3.8  | ---  | ns   |
| T <sub>r</sub>      | Rise Time                                      |                                                                                      | ---  | 25.8 | ---  |      |
| T <sub>d(off)</sub> | Turn-Off Delay Time                            |                                                                                      | ---  | 16   | ---  |      |
| T <sub>f</sub>      | Fall Time                                      |                                                                                      | ---  | 8.8  | ---  |      |
| C <sub>iss</sub>    | Input Capacitance                              | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz                                    | ---  | 620  | ---  | pF   |
| C <sub>oss</sub>    | Output Capacitance                             |                                                                                      | ---  | 105  | ---  |      |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                   |                                                                                      | ---  | 63   | ---  |      |

**Diode Characteristics**

| Symbol          | Parameter                                | Conditions                                                    | Min. | Typ. | Max. | Unit |
|-----------------|------------------------------------------|---------------------------------------------------------------|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current <sup>1,5</sup> | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current             | ---  | ---  | 15   | A    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,5</sup>     |                                                               | ---  | ---  | 25   | A    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C | ---  | ---  | 1.2  | V    |
| t <sub>rr</sub> | Reverse Recovery Time                    | I <sub>F</sub> =5A, dI/dt=100A/μs, T <sub>J</sub> =25°C       | ---  | 30   | ---  | nS   |
| Q <sub>rr</sub> | Reverse Recovery Charge                  |                                                               | ---  | 37   | ---  | nC   |

Note :

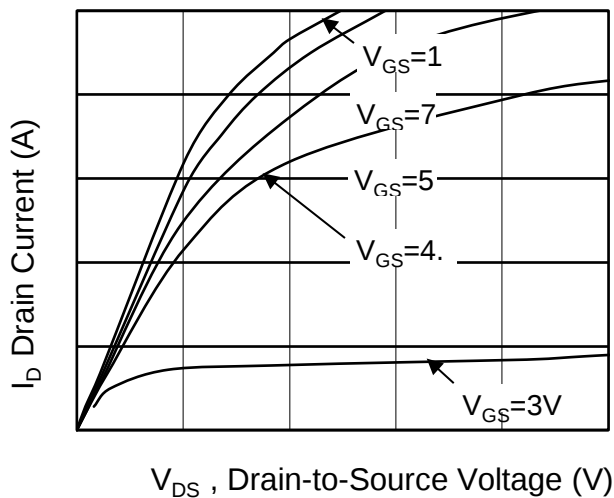
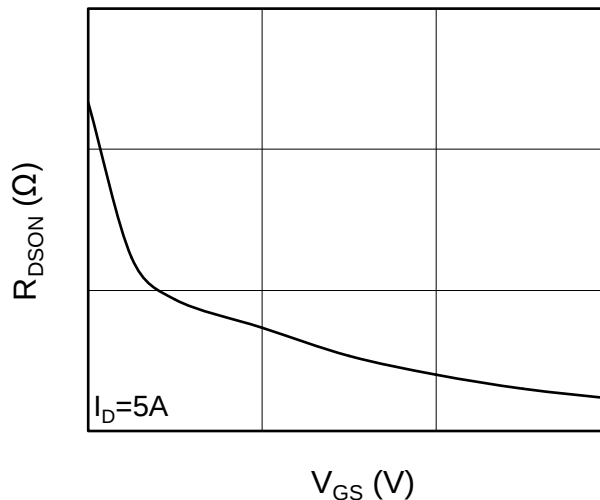
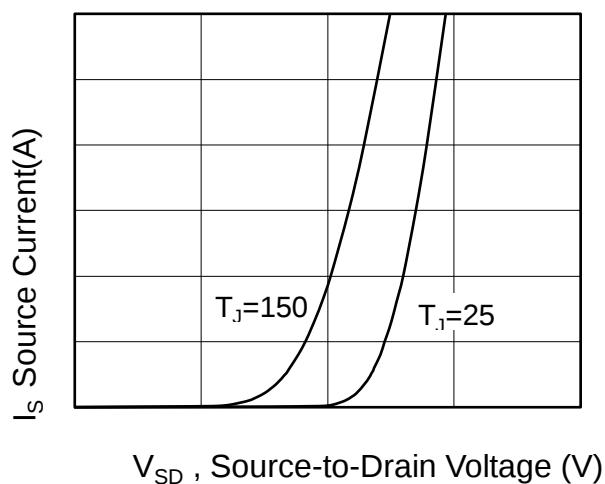
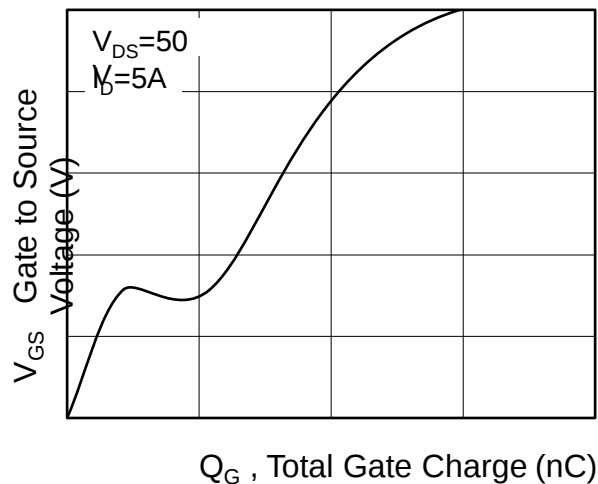
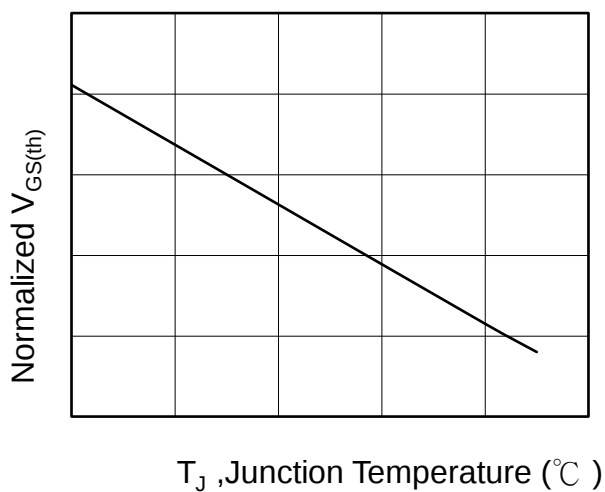
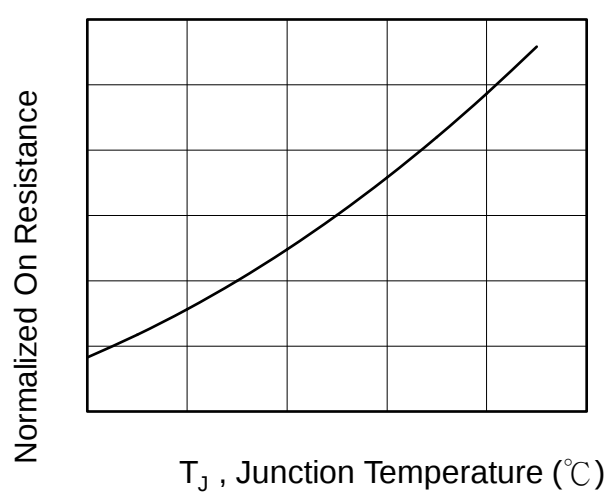
1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%

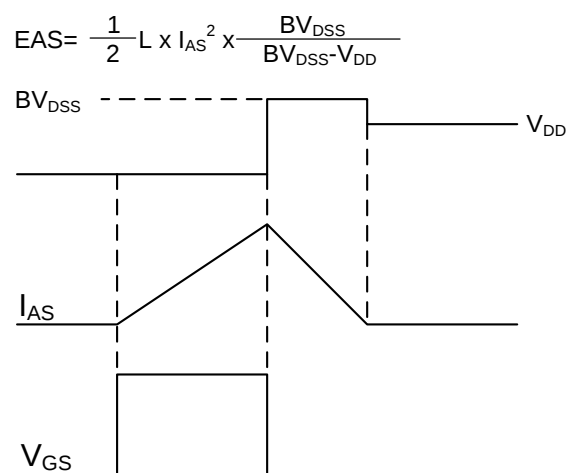
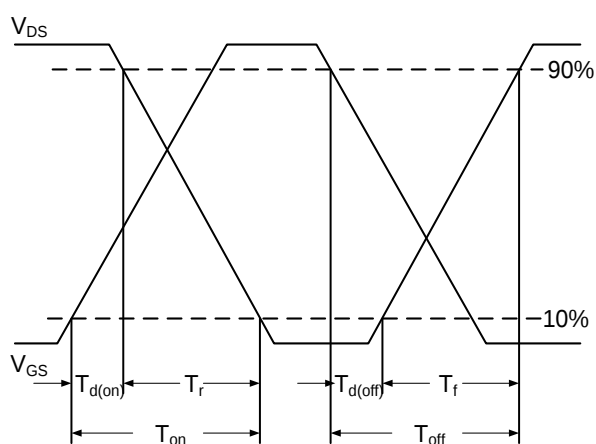
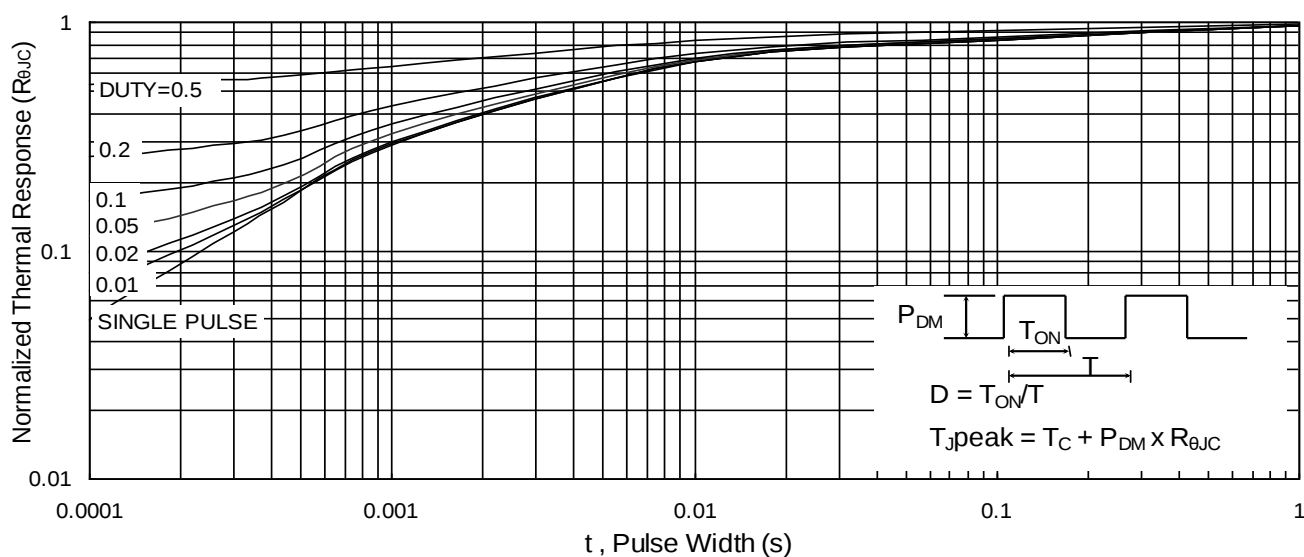
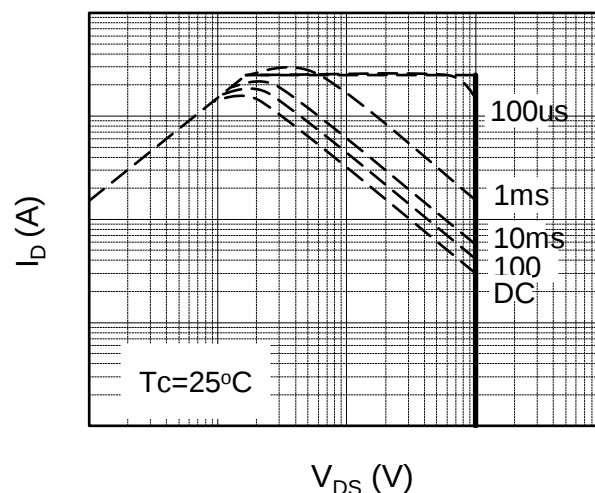
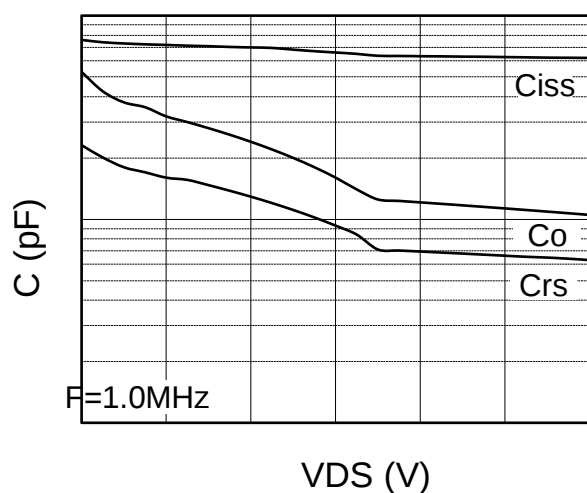
3.The EAS data shows Max. rating. The test condition is V<sub>DD</sub>=25V, V<sub>GS</sub>=10V, L=0.1mH, I<sub>AS</sub>=4A

4.The power dissipation is limited by 150°C junction temperature

5.The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.

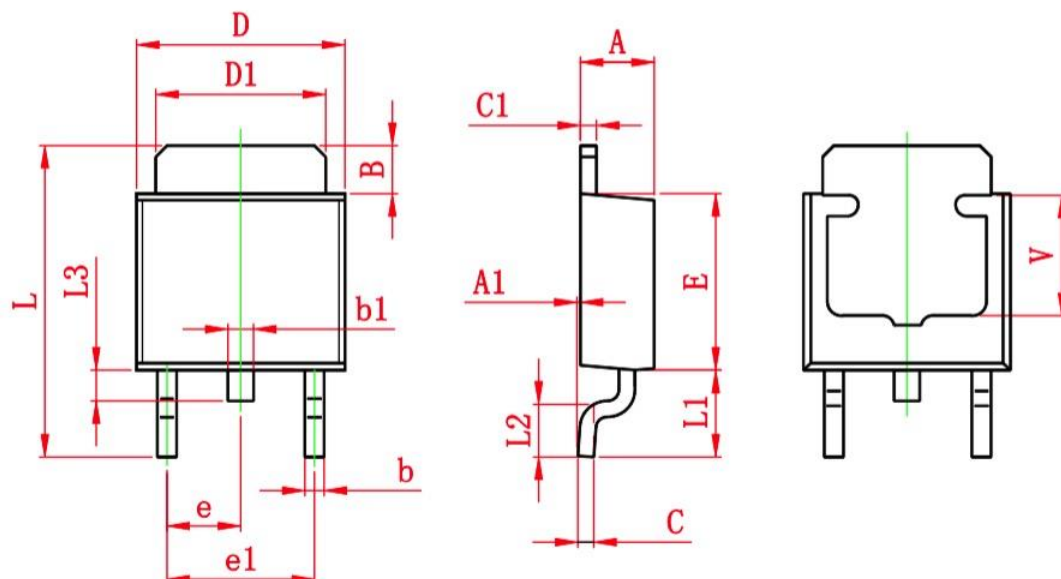
**N-Ch 100V Fast Switching MOSFETs**
**Typical Characteristics**

**Fig.1 Typical Output Characteristics**

**Fig.2 On-Resistance v.s Gate-Source**

**Fig.3 Forward Characteristics Of Reverse**

**Fig.4 Gate-Charge Characteristics**

**Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$** 

**Fig.6 Normalized  $R_{DS(on)}$  v.s  $T_J$**

## N-Ch 100V Fast Switching MOSFETs



## Ordering Information

| Part Number | Package code | Packaging      |
|-------------|--------------|----------------|
| HSU0028     | TO252-2      | 2500/Tape&Reel |



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 2.200                     | 2.400 | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127 | 0.000                | 0.005 |
| B      | 1.350                     | 1.650 | 0.053                | 0.065 |
| b      | 0.500                     | 0.700 | 0.020                | 0.028 |
| b1     | 0.700                     | 0.900 | 0.028                | 0.035 |
| c      | 0.430                     | 0.580 | 0.017                | 0.023 |
| c1     | 0.430                     | 0.580 | 0.017                | 0.023 |
| D      | 6.350                     | 6.650 | 0.250                | 0.262 |
| D1     | 5.200                     | 5.400 | 0.205                | 0.213 |
| E      | 5.400                     | 5.700 | 0.213                | 0.224 |
| e      | 2.300 TYP.                |       | 0.091 TYP.           |       |
| e1     | 4.500                     | 4.700 | 0.177                | 0.185 |
| L      | 9.500                     | 9.900 | 0.374                | 0.390 |
| L1     | 2.550                     | 2.900 | 0.100                | 0.114 |
| L2     | 1.400                     | 1.780 | 0.055                | 0.070 |
| L3     | 0.600                     | 0.900 | 0.024                | 0.035 |
| V      | 3.800 REF.                |       | 0.150 REF.           |       |